

C0816X7S0G105M050AC

TDK Item Description : C0816X7S0G105MT****

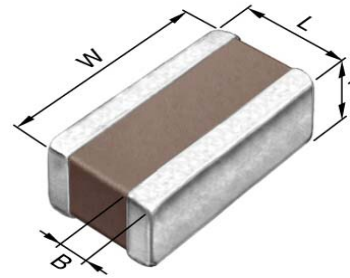


Application & Main Feature

Commercial Grade (Low ESL Reverse Geometry)

Series

C0816 [EIA CC0306]



Dimensions

L 0.80mm +/-0.15mm
 W 1.60mm +/-0.2mm
 T 0.50mm +/-0.1mm
 B 0.10mm Min.

Temperature Characteristic

X7S (-55 to 125 degC +/-22%)

Rated Voltage

0G (4Vdc)

Capacitance

1uF

Capacitance Tolerance

M (+/-20%)

Dissipation Factor

12% Max.

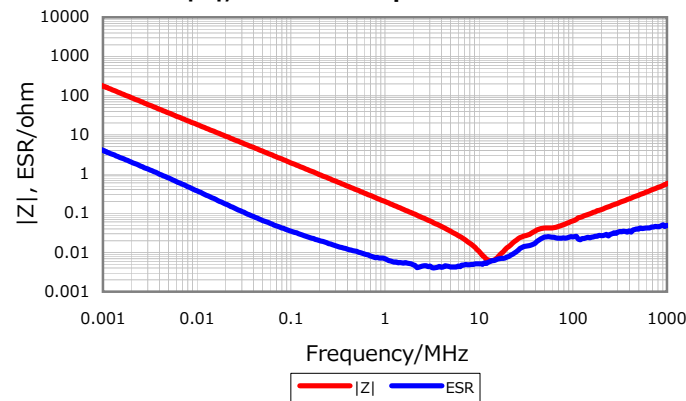
Insulation Resistance

100Mohm Min.

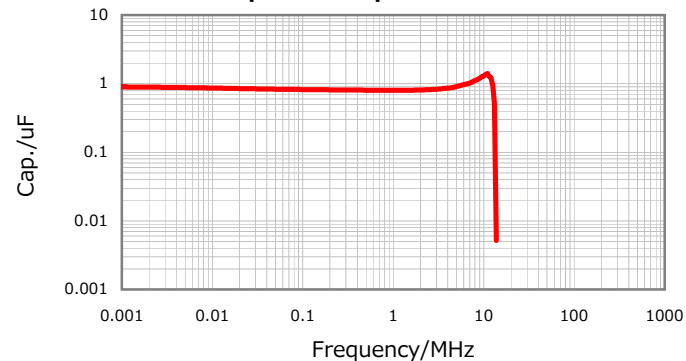
AEC-Q200

Not Applicable

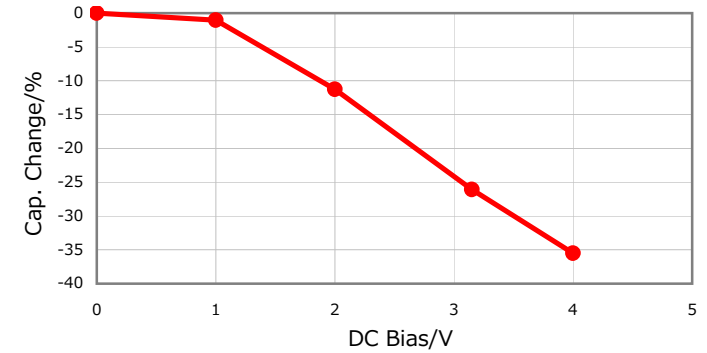
|Z|, ESR vs. Freq. Characteristics



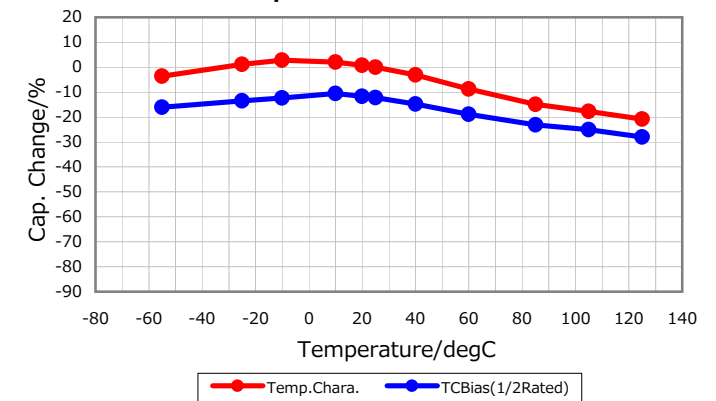
Cap. vs. Freq. Characteristic



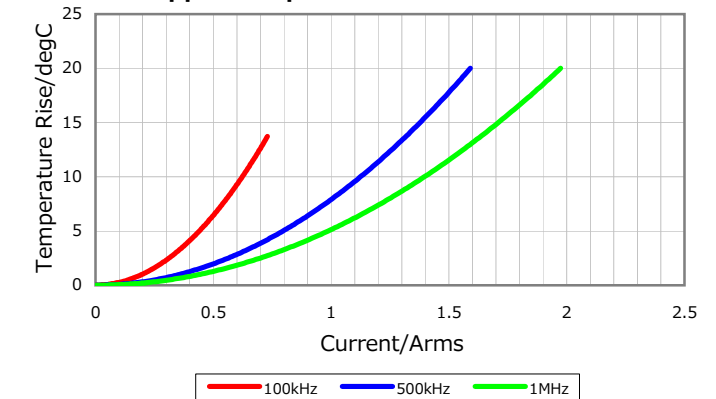
DC Bias Characteristic



Temperature Characteristics



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



All specifications are subject to change without notice.

January 3, 2016